

[54] COMBINED EARPHONE AND RECEIVER

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[**] Term: 14 Years

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[30] Foreign Application Priority Data

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[58] Field of Search D14/205-207, D14/223, 299, 168, 188, 192; 381/25, 68, 158, 183, 187; 379/430, 444; 181/129

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[57] CLAIM

The ornamental design for a combined earphone and receiver, as shown and described.

DESCRIPTION

FIG. 1 is an enlarged top, front and left-side perspective view of a combined earphone and receiver, showing my new design;

FIG. 2 is a front elevational view thereof;

FIG. 3 is a rear elevational view thereof;

FIG. 4 is a left-side elevational view thereof;

FIG. 5 is a right-side elevational view thereof;

FIG. 6 is a top plan view thereof; and

FIG. 7 is a bottom plan view thereof.

The connecting wire is broken away in the drawings for ease of illustration.

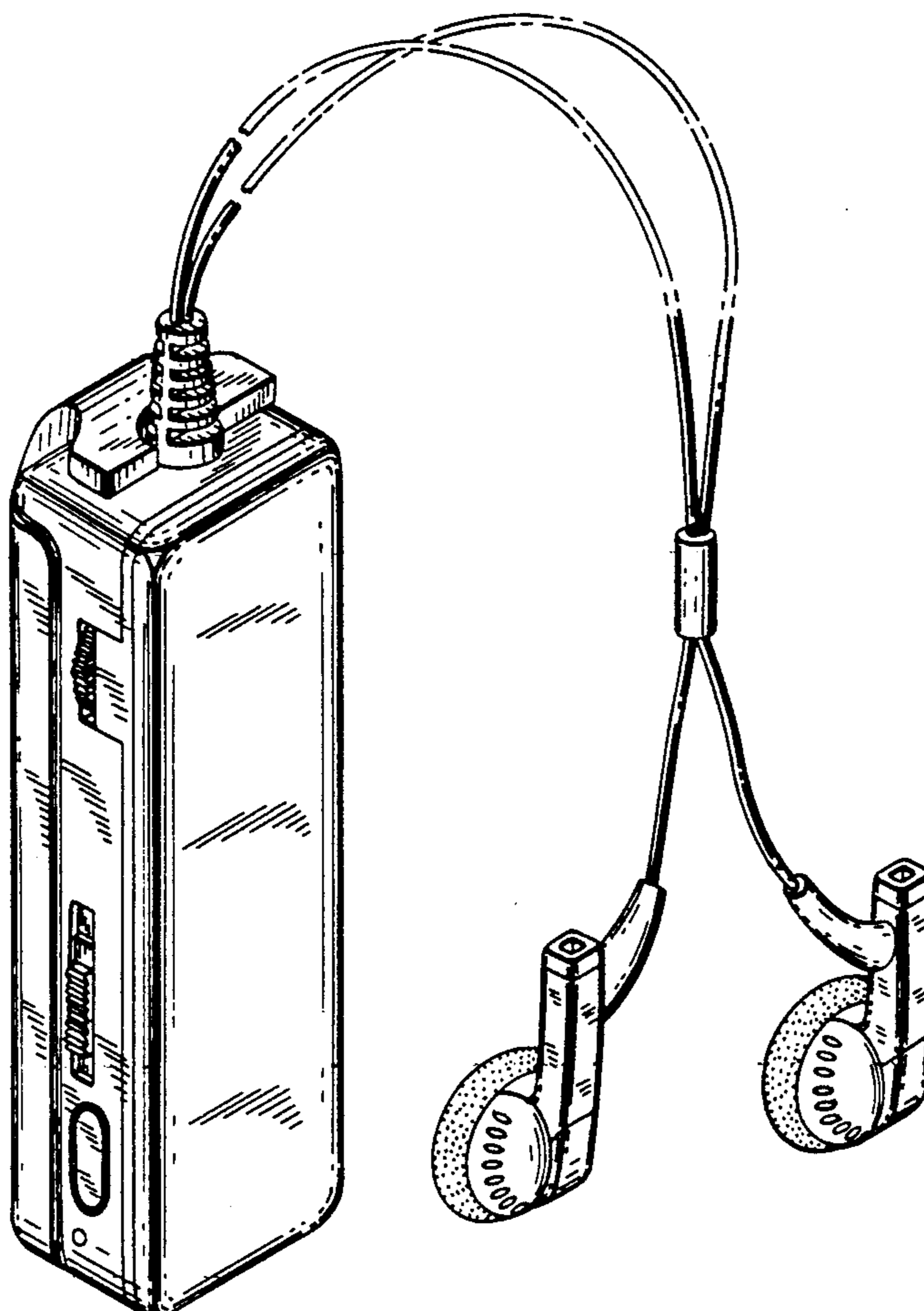


FIG. 1

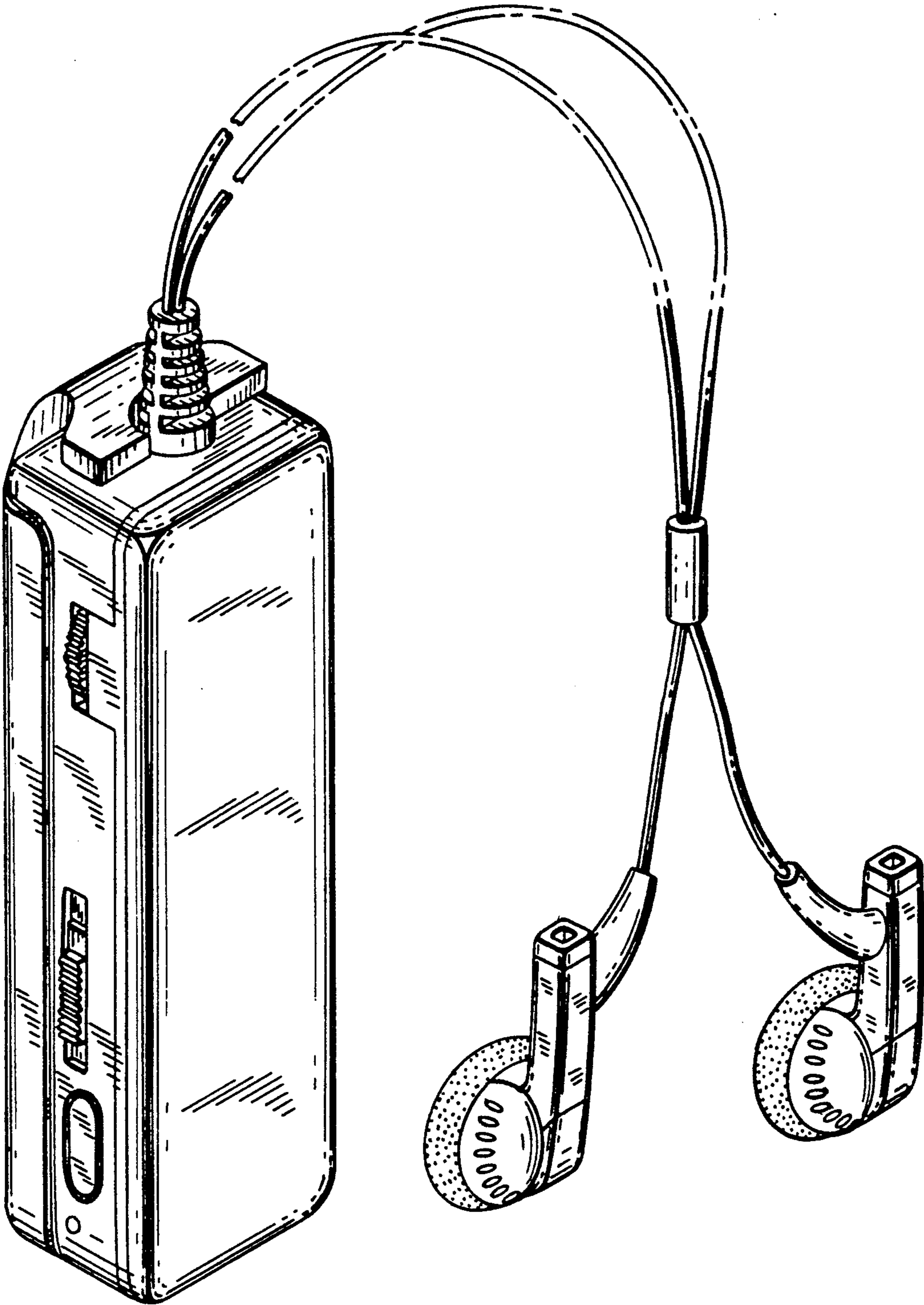


FIG. 2

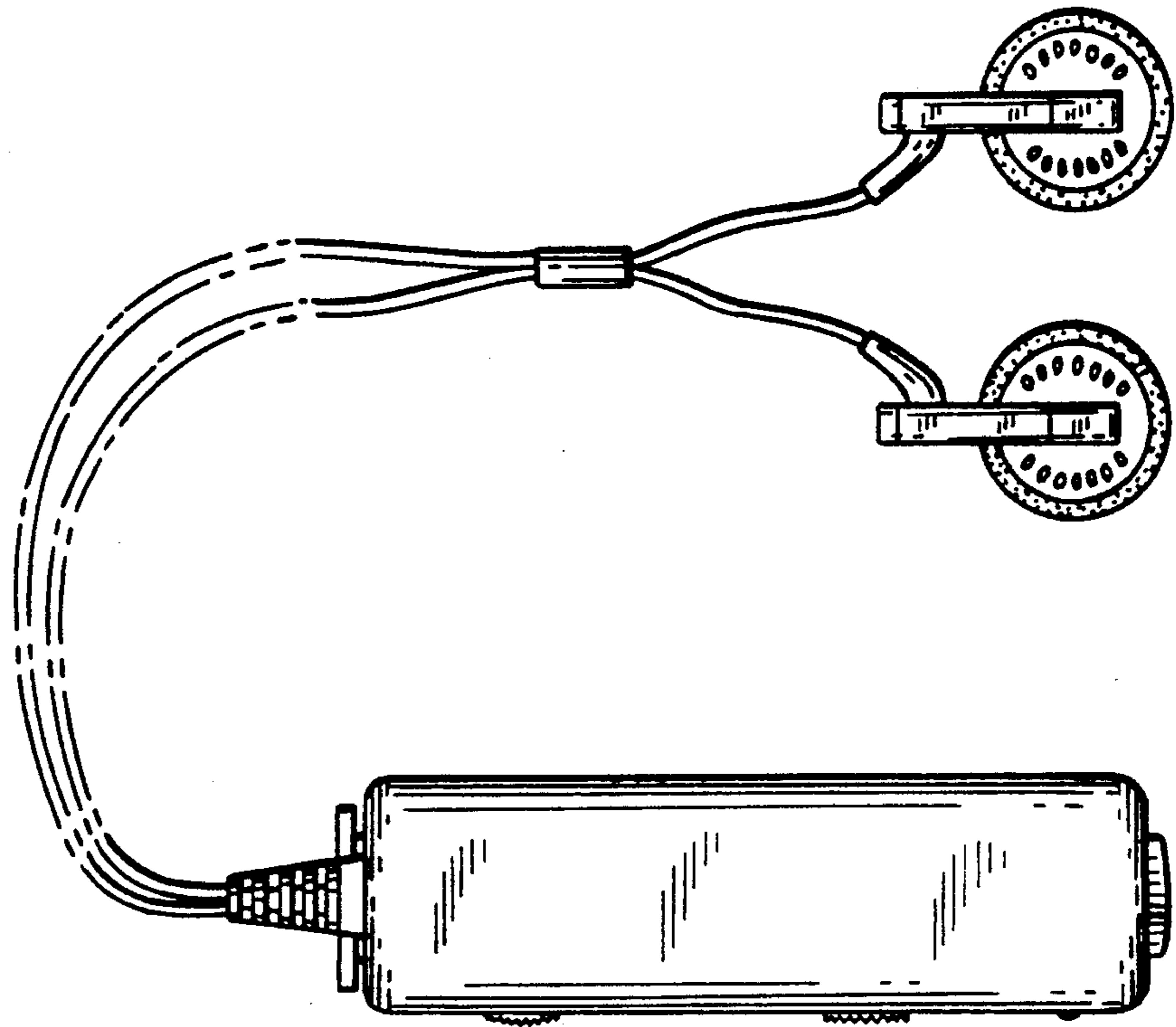


FIG. 4

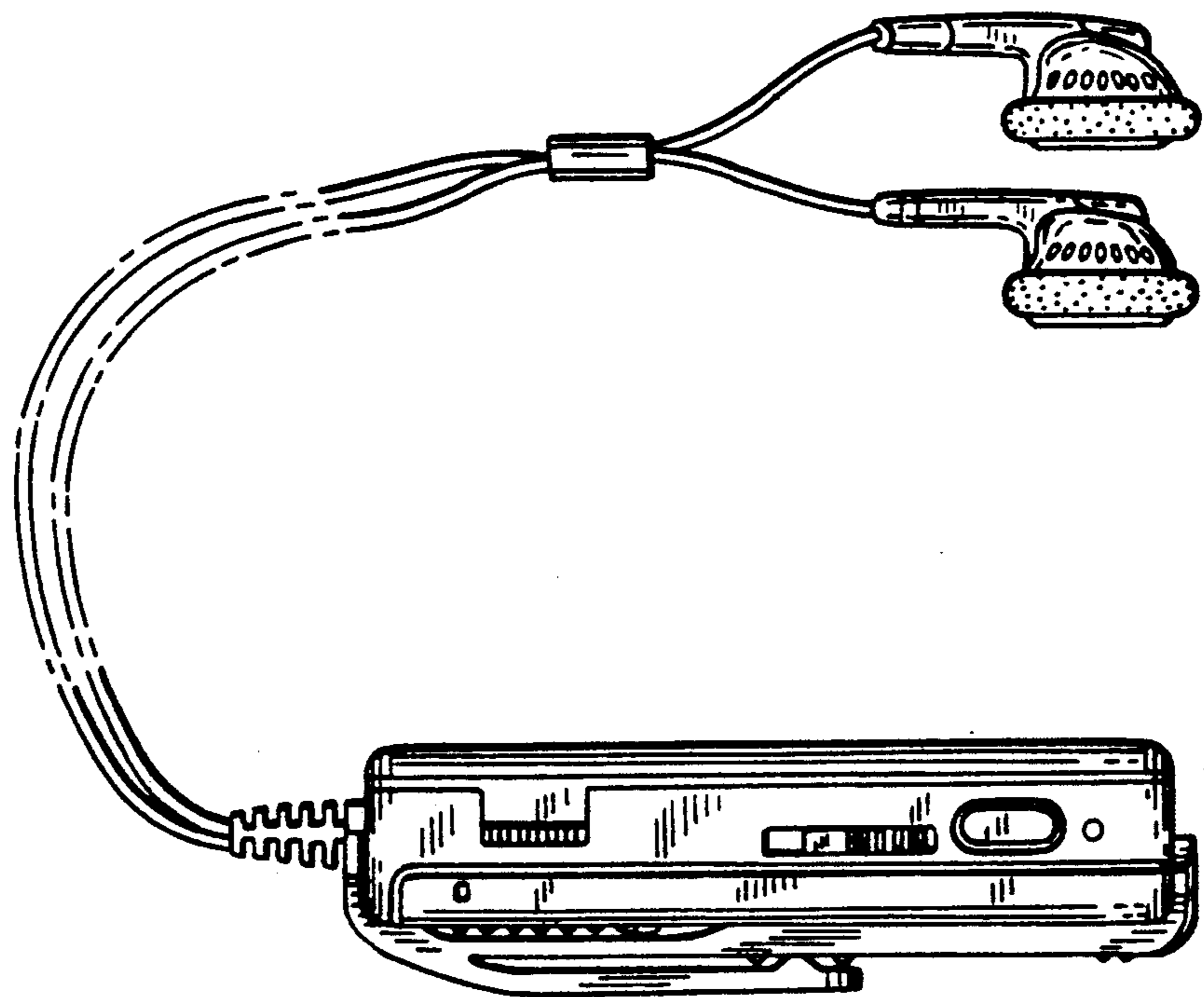


FIG. 3

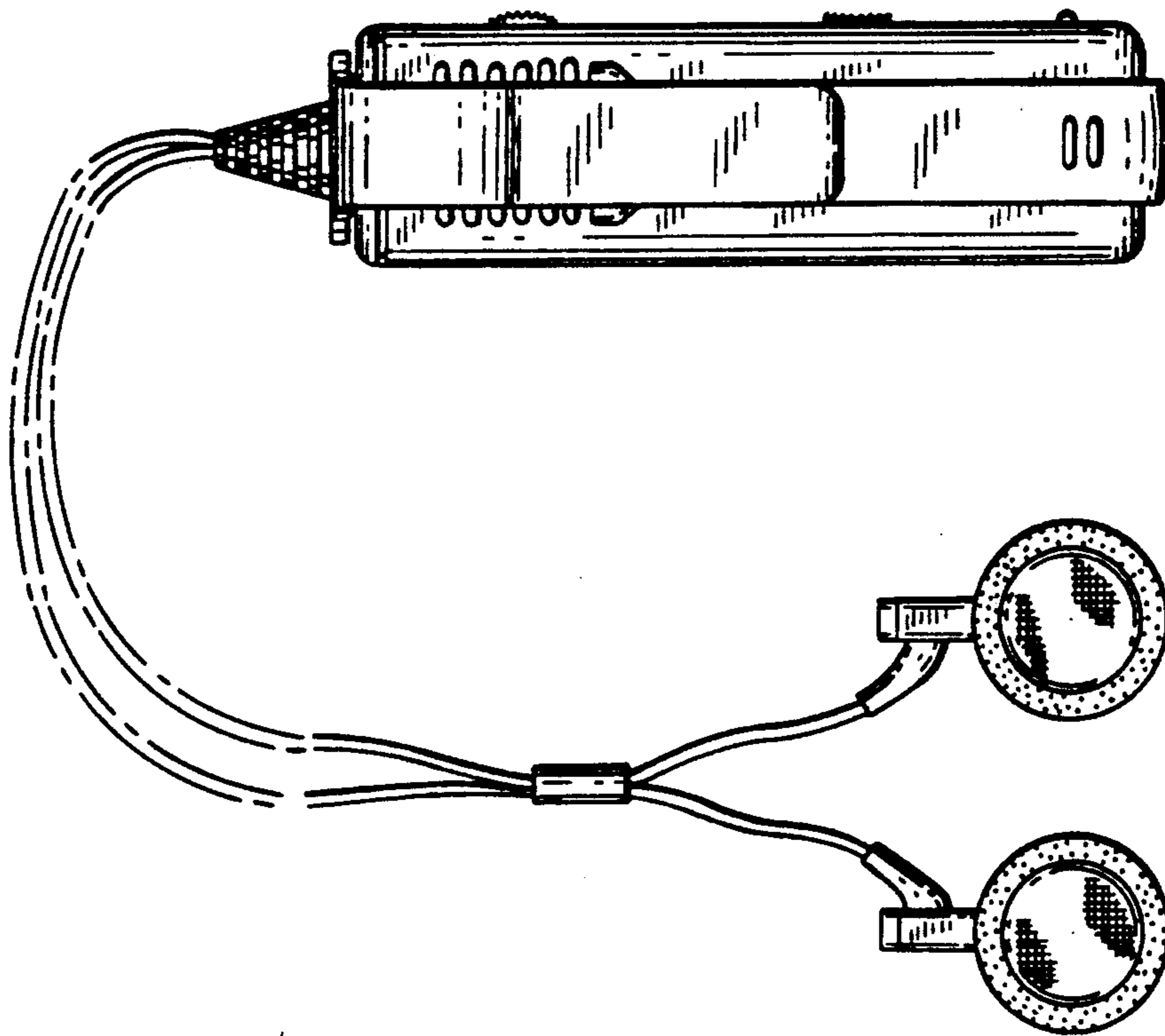


FIG. 6

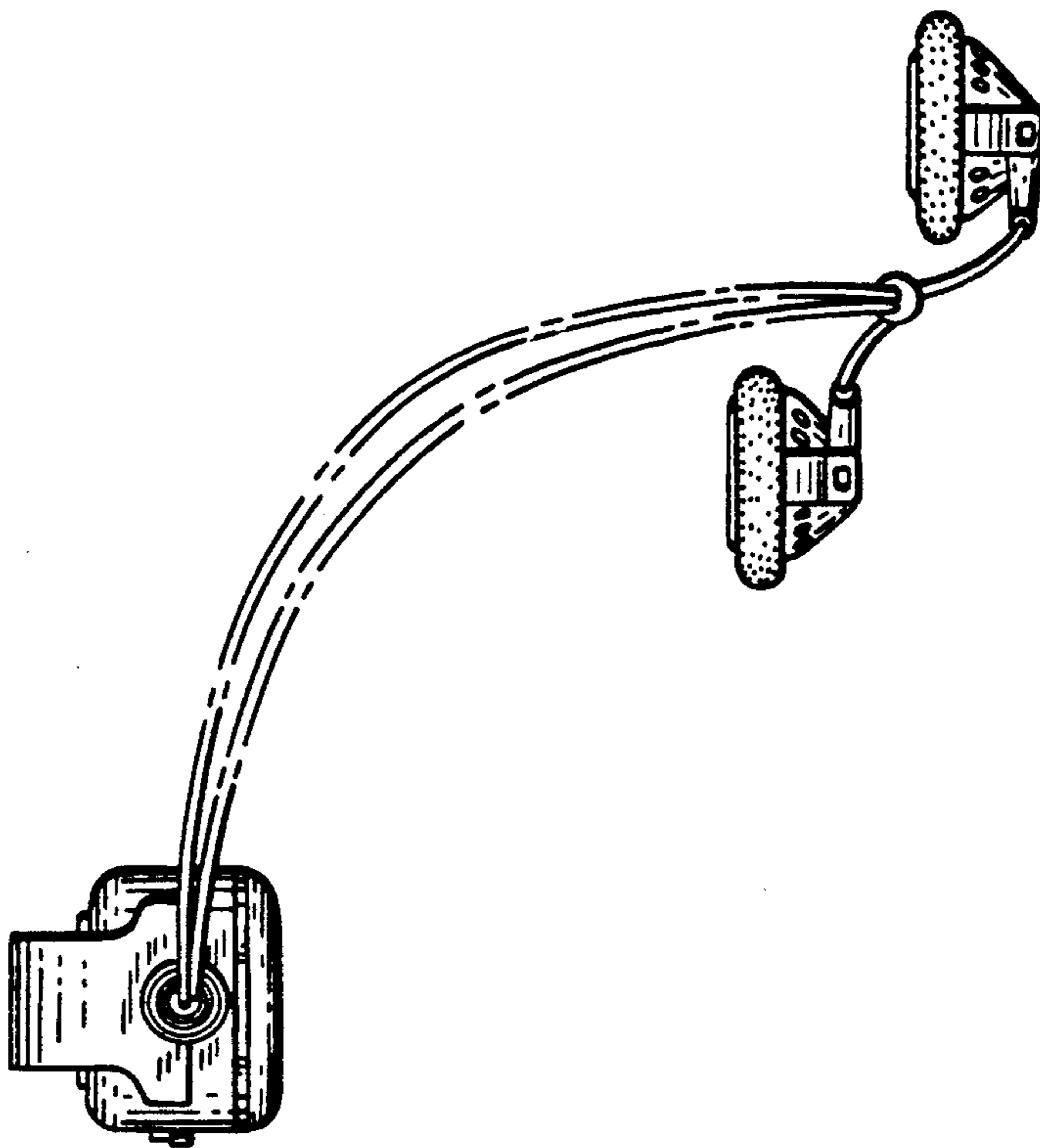


FIG. 5

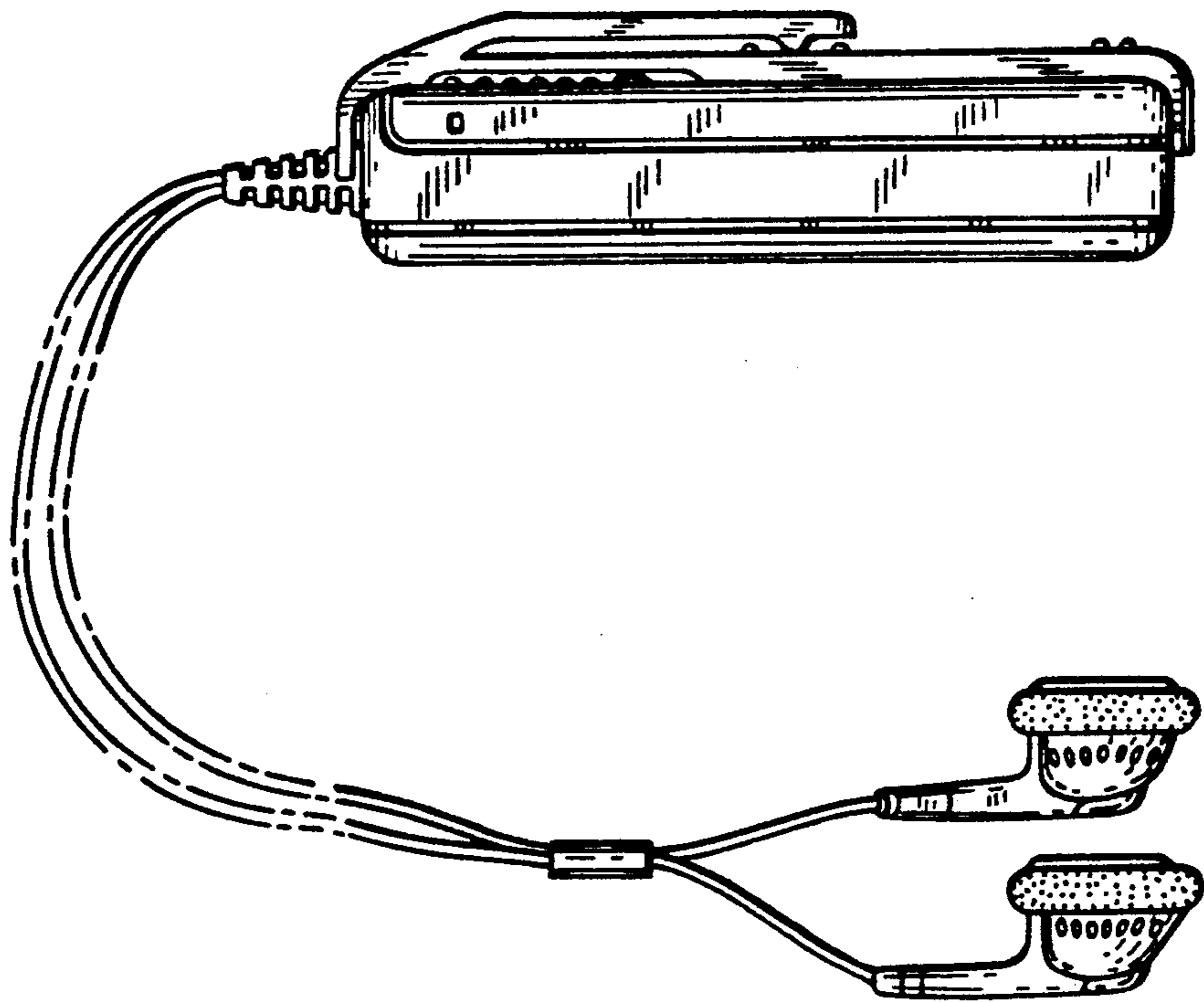


FIG. 7

